



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Bily WANG

Serial No. 09/922,688

Filed: Aug. 7, 2001

For: FOCUSING CUP IN A STACKED SUBSTRATE

AMENDMENT (clear version)

Commissioner of Patents

Washington, D.C. 20231

Sir:

In response to USPTO communication dated Oct. 2, 2002, please amend the application as follows:

IN THE CLAIMS:

Please cancel claims 1-6.

Please rewrite claim 7 as follows:

--7. (twice amended) A method for fabricating a focusing cup for an optoelectronic device package comprising the steps of:

forming a through hole in an upper insulating substrate, wherein said through hole is of conical shape;

stacking said upper insulating substrate over a lower insulating substrate; and

mounting an optoelectronic device on said lower substrate inside said through hole; and

inserting at least a metallic plate between said optoelectronic device and said lower substrate

extending beyond the bottom of said cup to enhance heat sinking and light reflection.--

Please rewrite claim 9 as follows:

--9 (twice amended) The method as described in claim 7, further comprising the step of lining the wall of said through hole with metal coating to enhance light reflection.--

Please cancel claim 13.

Please rewrite claim 14 as follows:

--14. (twice amended) A package for optoelectronic device comprising:

an upper insulating substrate;

a lower insulating substrate;

a through hole in said upper insulating substrate;

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